



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	R _{DS(ON)} max	I _D max T _A = +25°C		
20V	0.99Ω @ V _{GS} = 4.5V	0.55A		
	1.2Ω @ V _{GS} = 2.5V	0.50A		
	1.8Ω @ VGS = 1.8V	0.41A		
	2.4Ω @ V _{GS} = 1.5V	0.35A		

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- · General purpose interfacing switches
- Power management functions
- Analog switches

Features and Benefits

- Low Package Profile, 0.42mm Maximum Package Height
- 0.62mm × 0.62mm Package Footprint
- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V Maximum
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2991UFZQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

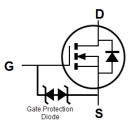
- Package: X2-DFN0606-3
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.001 grams (Approximate)



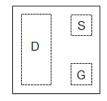


X2-DFN0606-3

Bottom View



Equivalent Circuit



Top View Package Pin Configuration

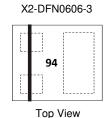
Ordering Information (Note 4)

Part Number	Package	Packing		
Part Number	Fackage	Qty.	Carrier	
DMN2991UFZQ-7B	X2-DFN0606-3	10k	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



94 = Product Type Marking Code
Bar Denotes Gate and Source Side



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 5) V _{GS} = 4.5V	ID	0.55 0.44	А		
Maximum Body Diode Forward Current (Note 6)			Is	0.7	Α
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)			I _{DM}	1.5	Α

Thermal Characteristics (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)	Steady State	PD	0.45	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	279	°C/W
Power Dissipation (Note 6)	Steady State	P _D	0.53	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	148	°C/W
Operating and Storage Temperature Range	·	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

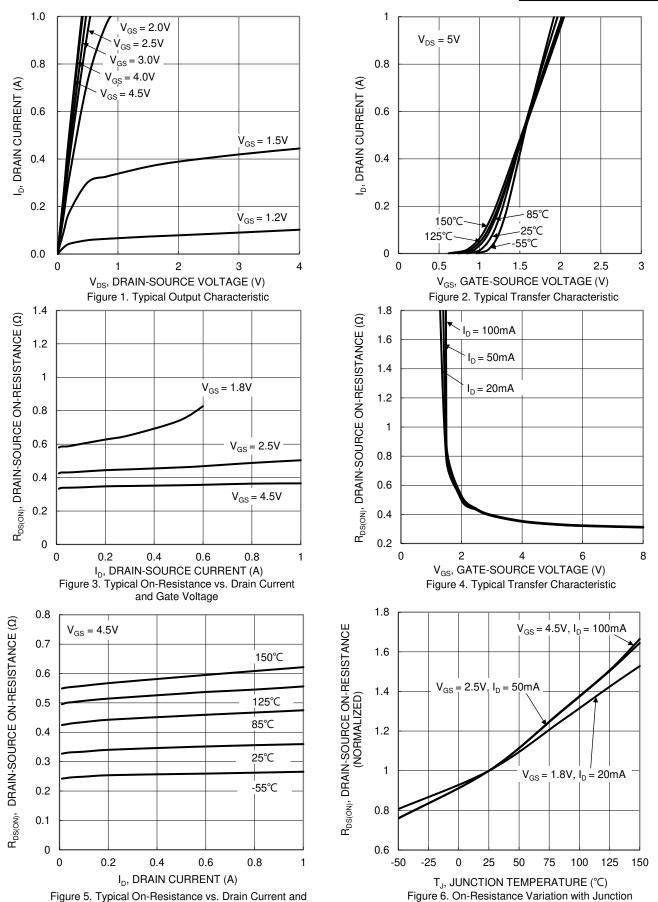
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	20	l	_	٧	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS		l	1	μΑ	V _{DS} = 16V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}		_	1	μΑ	$V_{GS} = \pm 5V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.4		1.0	V	$V_{DS}=V_{GS},\ I_D=250\mu A$	
		1	0.60	0.99	Ω	$V_{GS} = 4.5V, I_D = 100mA$	
Static Drain-Source On-Resistance	Descent	1	0.75	1.2		$V_{GS} = 2.5V, I_{D} = 50mA$	
Static Diain-Source Off-nesistatice	RDS(ON)		0.90	1.8		$V_{GS} = 1.8V, I_{D} = 20mA$	
			1.2	2.4		$V_{GS} = 1.5V, I_D = 10mA$	
Diode Forward Voltage	V _{SD}	-	0.6	1.0	V	V _G S = 0V, I _S = 150mA	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	Ciss		14.6	_	pF	., ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	
Output Capacitance	Coss		4.7	_	pF	V _{DS} = 16V, V _{GS} = 0V -f = 1.0MHz	
Reverse Transfer Capacitance	Crss		3.2	_	pF	1 = 1.0IVID2	
Total Gate Charge	Qg		0.28	_	nC	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Gate-Source Charge	Qgs	_	0.04	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V$ $I_{D} = 250mA$	
Gate-Drain Charge	Q_{gd}	_	0.1	_	nC		
Turn-On Delay Time	t _{D(ON)}		7.1	_	ns	V _{DD} = 10V, V _{GS} = 4.5V	
Turn-On Rise Time	tR	_	18	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	125	_	ns	$R_L = 47\Omega$, $R_G = 10\Omega$ $I_D = 200 \text{mA}$	
Turn-Off Fall Time	t _F	_	56.9		ns	110 – 20011IA	

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.







Junction Temperature

Temperature





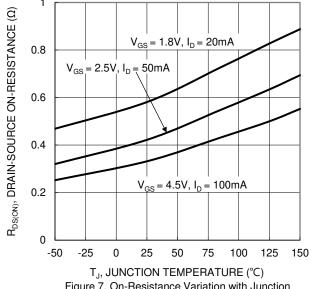


Figure 7. On-Resistance Variation with Junction Temperature

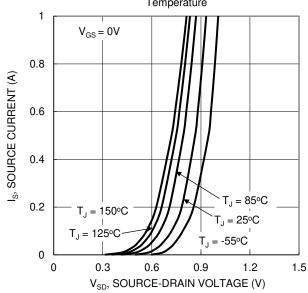


Figure 9. Diode Forward Voltage vs. Current

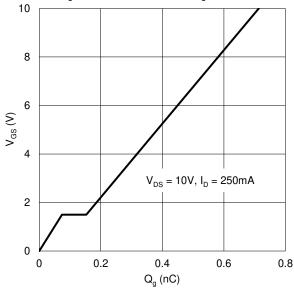


Figure 11. Gate Charge

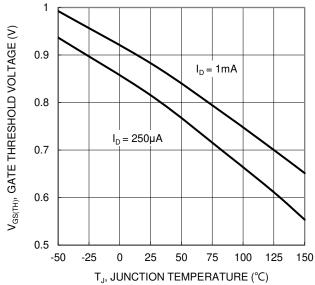


Figure 8. Gate Threshold Variation vs. Junction Temperature

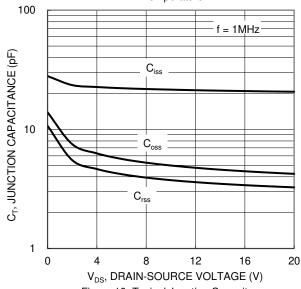
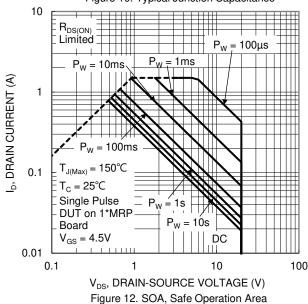


Figure 10. Typical Junction Capacitance





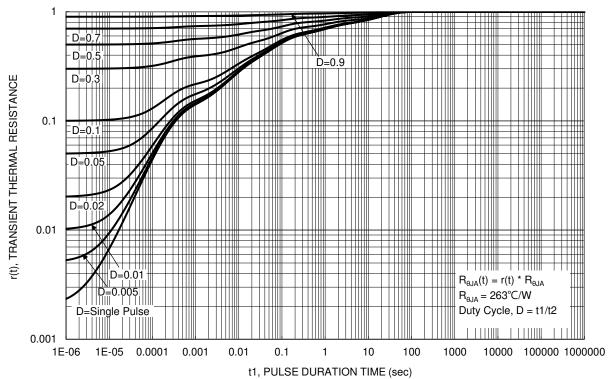


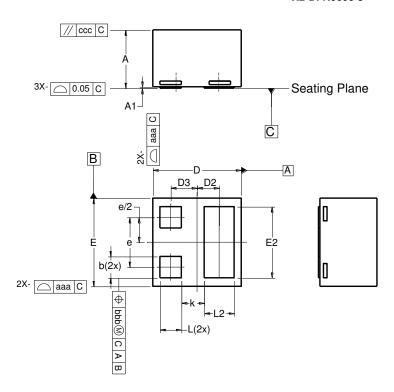
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0606-3

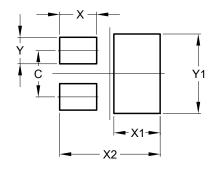


X2-DFN0606-3				
Dim	Min	Тур		
Α	0.36	0.40	0.39	
A 1	0.00	0.05	0.02	
b	0.10	0.20	0.15	
D	0.57	0.67	0.62	
D2	0.	155 BS	SC	
D3	0.	185 BS	SC	
Е	0.57	0.57 0.67 0.		
E2	0.40	0.60	0.50	
е	0.35 BSC			
k	0.16 REF			
L	0.10	0.20	0.15	
L2	0.11	0.31	0.21	
aaa	0.08			
bbb	0.07			
CCC	0.05			
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0606-3



Dimensions	Value (in mm)		
С	0.350		
Х	0.280		
X1	0.350		
X2	0.760		
Υ	0.200		
Y1	0.600		



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